

Absolute Maximum Ratings

V_{CC} , AVCC to GND.....-0.3V to +6V
 LXN to V_{CC} -18V to +0.3V
 LXP to PGND-0.3V to +33V
 REF, ONINV, ONBST, SEQ, FBN, FBP
 FLT to GND-0.3V to (AVCC + 0.3)V
 PVP to GND-0.3V to (V_{CC} + 0.3)V
 AVCC to V_{CC}-0.3V to +0.3V
 PGND to GND-0.3V to +0.3V

Continuous Power Dissipation ($T_A = +70^\circ\text{C}$ Multilayer Board)
 14-Pin 3mm x 3mm TDFN (derate 18.2mW/ $^\circ\text{C}$ above
 $T_A = +70^\circ\text{C}$).....1454.4mW
 Operating Temperature Range.....-40 $^\circ\text{C}$ to +85 $^\circ\text{C}$ /125 $^\circ\text{C}$
 Junction Temperature.....+150 $^\circ\text{C}$
 Storage Temperature Range.....-65 $^\circ\text{C}$ to +150 $^\circ\text{C}$
 Lead Temperature (soldering, 10s)+300 $^\circ\text{C}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Electrical Characteristics

($V_{CC} = V_{AVCC} = V_{ONINV} = V_{ONBST} = 3.6\text{V}$, PGND = SEQ = GND, C6 = 0.22 μF , C1 = 2.2 μF , C2 = 4.7 μF , Figure 1, $T_A = 0^\circ\text{C}$ to +85 $^\circ\text{C}$, unless otherwise noted. Typical values are at $T_A = +25^\circ\text{C}$.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
AVCC and V_{CC} Voltage Range	(Note 1)	2.7		5.5	V
UVLO Threshold	V_{CC} rising	2.42	2.55	2.66	V
UVLO Hysteresis			25		mV
Step-Up Output-Voltage Adjust Range		V_{AVCC}		24	V
Inverter Output-Voltage Adjust Range	$V_{INV} - V_{CC}$ (Note 2)	-16		0	V
LXP Current Limit	MAX8614B	0.7	0.8	0.9	A
	MAX8614A	0.34	0.44	0.52	
LXP Short-Circuit Current Limit	MAX8614B	0.90	1.05	1.20	A
	MAX8614A	0.52	0.61	0.70	
LXN Current Limit	MAX8614B	0.65	0.75	0.85	A
	MAX8614A	0.28	0.33	0.38	
LXN On-Resistance	$V_{CC} = 3.6\text{V}$		0.6	1.1	Ω
LXP On-Resistance	$V_{CC} = 3.6\text{V}$		0.625		Ω
PVP On-Resistance	$V_{CC} = 3.6\text{V}$		0.15	0.3	Ω
Maximum Duty Cycle	Step-up and inverter	82	90		%
Quiescent Current (Switching, No Load)	I_{AVCC}		0.75	1.4	mA
	I_{VCC}		2	3	
Quiescent Current (No Switching, No Load)	I_{AVCC}		400	800	μA
	I_{VCC}		8	15	
Shutdown Supply Current	$T_A = +25^\circ\text{C}$		0.1	5	μA
	$T_A = +85^\circ\text{C}$		0.1		
FBP Line Regulation	$V_{CC} = 2.7\text{V}$ to 5.5V		-20		mV/D
FBN Line Regulation	$V_{CC} = 2.7\text{V}$ to 5.5V		20		mV/ (D - 0.5)

Electrical Characteristics (continued)

($V_{CC} = V_{AVCC} = V_{ONINV} = V_{ONBST} = 3.6V$, $PGND = SEQ = GND$, $C6 = 0.22\mu F$, $C1 = 2.2\mu F$, $C2 = 4.7\mu F$, Figure 1, $T_A = 0^\circ C$ to $+85^\circ C$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
FBP Load Regulation	I _{LXP} = I _{ILIMMIN} , MAX8614B		-15			mV/A
	I _{LXP} = I _{ILIMMIN} , MAX8614A		-35			
FBN Load Regulation	I _{LXN} = I _{ILIMMIN} , MAX8614B		17.5			mV/A
	I _{LXN} = I _{ILIMMIN} , MAX8614A		65			
Oscillator Frequency			0.93	1	1.07	MHz
Soft-Start Interval	Step-up and inverter		10			ms
Overload-Protection Fault Delay			100			ms
FBP, FBN, REFERENCE						
REF Output Voltage	No load		1.24	1.25	1.26	V
REF Load Regulation	0μA < I _{REF} < 50μA		10			mV
REF Line Regulation	3.3V < V _{AVCC} < 5.5V		2 5			mV
FBP Threshold Voltage	No load		0.995	1.010	1.025	V
FBN Threshold Voltage	No load		-10	0	+10	mV
FBP Input Leakage Current	V _{FBP} =1.025V	T _A = +25°C	-50	+5	+50	nA
		T _A = +85°C	+5			
FBN Input Leakage Current	FBN = -10mV	T _A = +25°C	-50	+5	+50	nA
		T _A = +85°C	+5			
LXN Input Leakage Current	V _{LXN} = -12V	T _A = +25°C	-5	+0.1	+5	μA
		T _A = +85°C	+0.1			
LXP Input Leakage Current	V _{LXP} = 23V	T _A = +25°C	-5	+0.1	+5	μA
		T _A = +85°C	+0.1			
PVP Input Leakage Current	V _{PVP} = 0V	T _A = +25°C	-5	+0.1	+5	μA
		T _A = +85°C	+0.1			
FLT Input Leakage Current	V _{FLT} = 3.6V	T _A = +25°C	-1	+0.1	+1	μA
		T _A = +85°C	+0.1			
FLT Input Resistance	Fault mode, T _A = +25°C		10 20			Ω
ONINV, ONBST, SEQ LOGIC INPUTS						
Logic-Low Input	2.7V < V _{AVCC} < 5.5V		0.5			V
Logic-High Input	2.7V < V _{AVCC} < 5.5V		1.6			V
Bias Current	T _A = +25°C		0.1 1			μA

Electrical Characteristics

($V_{CC} = V_{AVCC} = V_{ONINV} = V_{ONBST} = V_{EN} = 3.6V$, PGND = SEQ = GND, C6 = 0.22 μ F, C1 = 2.2 μ F, C2 = 6.7 μ F, Figure 1, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted.) (Note 3)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
AVCC = V _{CC} Voltage Range	(Note 1)	3		5.5	V
UVLO Threshold	V _{CC} rising	2.42		2.82	V
Step-Up Output Voltage Adjust Range		V _{AVCC}		24	V
Inverter Output Voltage Adjust Range	V _{INV} - V _{CC} (Note 2)	-16		0	V
LXP Current Limit	MAX8614B	0.7		0.9	A
	MAX8614A	0.34		0.52	
LXP Short-Circuit Current Limit	MAX8614B	0.9		1.2	A
	MAX8614A	0.52		0.70	
LXN Current Limit	MAX8614B	0.65		0.85	A
	MAX8614A	0.28		0.38	
LXN On-Resistance	V _{CC} = 3.6V			1.1	Ω
PVP On-Resistance	V _{CC} = 3.6V			0.3	Ω
Maximum Duty Cycle	Step-up and inverter	82			%
Quiescent Current (Switching, No Load)	I _{AVCC}			1.4	mA
	I _{VCC}			3	
Quiescent Current (No Switching, No Load)	I _{AVCC}			800	μ A
	I _{VCC}			15	
Oscillator Frequency		0.93		1.07	MHz
FBP, FBN, REFERENCE					
REF Output Voltage	No load	1.235		1.260	V
FBP Threshold Voltage	No load	0.995		1.025	V
FBN Threshold Voltage	No load	-10		+10	mV
ONINV, ONBST SEQ LOGIC INPUTS					
Logic-Low Input	2.7V < V _{AVCC} < 5.5V			0.5	V
Logic-High Input	2.7V < V _{AVCC} < 5.5V	1.6			V

Electrical Characteristics

($V_{CC} = V_{AVCC} = V_{ONINV} = V_{ONBST} = V_{EN} = 3.6V$, $PGND = SEQ = GND$, $C6 = 0.22\mu F$, $C1 = 2.2\mu F$, $C2 = 6.7\mu F$, Figure 1, MAX8614BATD/V+, $T_A = -40^{\circ}C$ to $+125^{\circ}C$, unless otherwise noted)(Note 3)

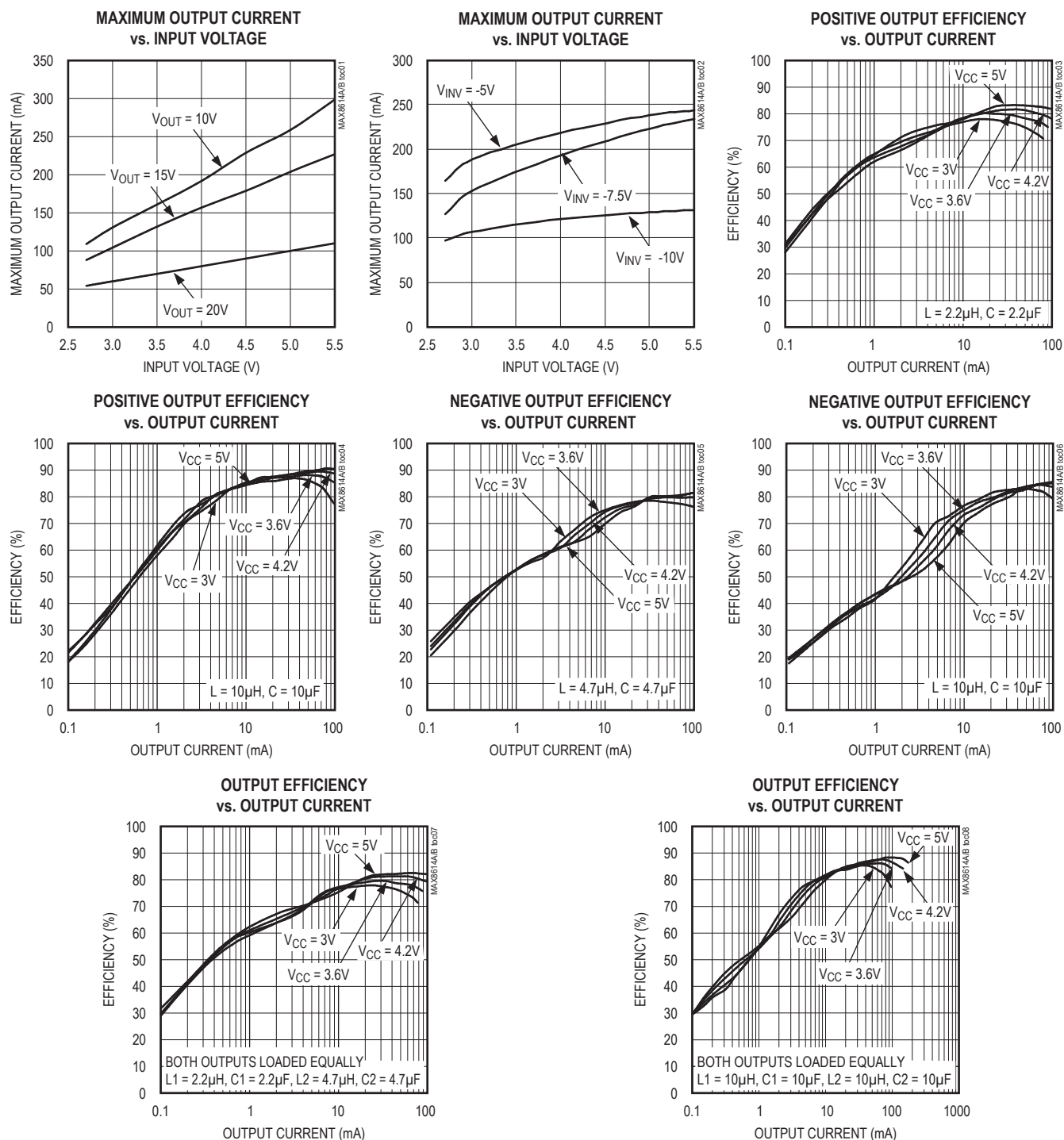
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$AVCC = V_{CC}$ Voltage Range	(Note 1)	3		5.5	V
UVLO Threshold	V_{CC} rising	2.42		2.82	V
Step-Up Output Voltage Adjust Range		V_{AVCC}		24	V
Inverter Output Voltage Adjust Range	$V_{INV} - V_{CC}$ (Note 2)	-16		0	V
LXP Current Limit		0.7		0.9	A
		0.34		0.52	
LXP Short-Circuit Current Limit		0.9		1.2	A
		0.52		0.70	
LXN Current Limit		0.65		0.85	A
		0.28		0.38	
LXN On-Resistance	$V_{CC} = 3.6V$			1.1	Ω
PVP On-Resistance	$V_{CC} = 3.6V$			0.3	Ω
Maximum Duty Cycle	Step-up and inverter	82			%
Quiescent Current (Switching, No Load)	I_{AVCC}			1.4	mA
	I_{VCC}			3	
Quiescent Current (No Switching, No Load)	I_{AVCC}			800	μA
	I_{VCC}			15	
Oscillator Frequency		0.93		1.07	MHz
FBP, FBN, REFERENCE					
REF Output Voltage	No load	1.235		1.260	V
FBP Threshold Voltage	No load	0.995		1.025	V
FBN Threshold Voltage	No load	-10		+10	mV
ONINV, ONBST SEQ LOGIC INPUTS					
Logic-Low Input	$2.7V < V_{AVCC} < 5.5V$			0.5	V
Logic-High Input	$2.7V < V_{AVCC} < 5.5V$	1.6			V

Note 1: Output current and on-resistance are specified at 3.6V input voltage. The IC operates to 2.7V with reduced performance.

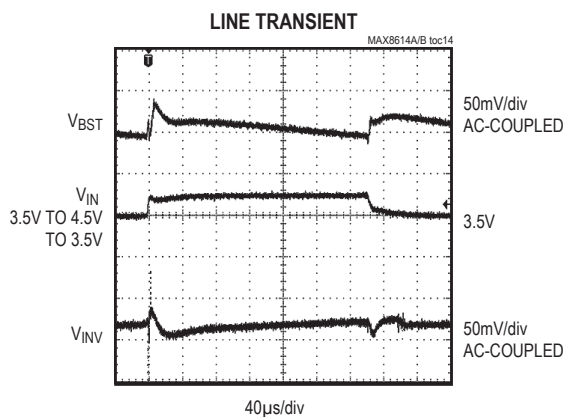
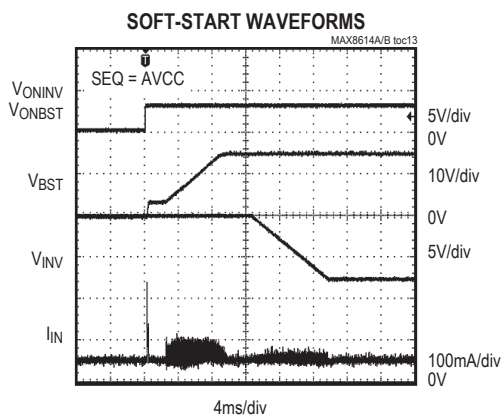
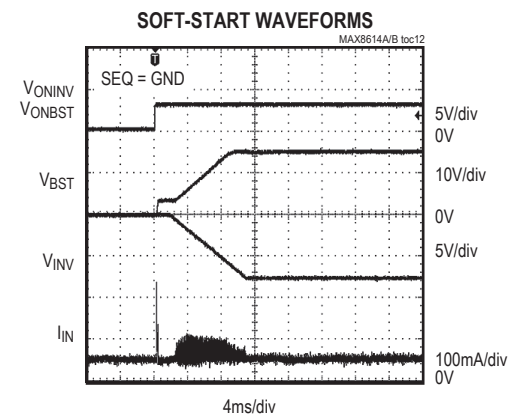
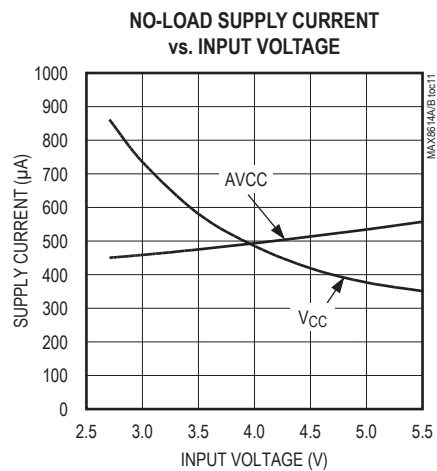
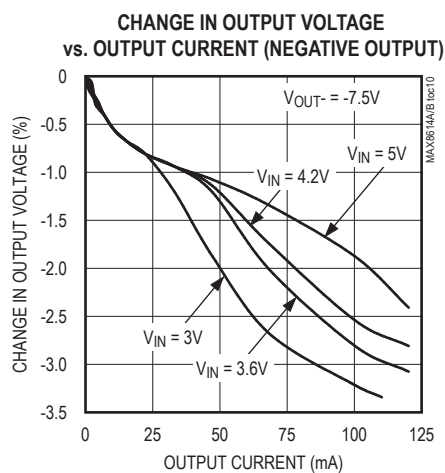
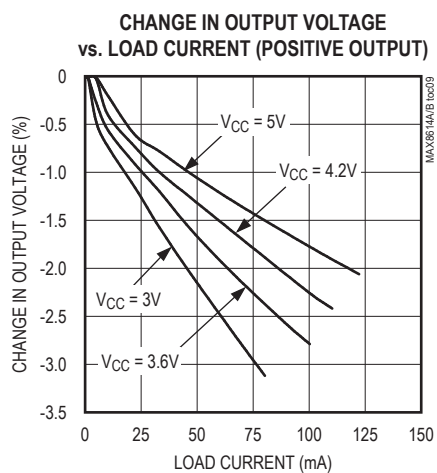
Note 2: The specified maximum negative output voltage is referred to V_{CC} , and not to GND. With $V_{CC} = 3.3V$, the maximum negative output is then -12.7V.

Note 3: Specifications to $-40^{\circ}C$ are guaranteed by design, not production tested.

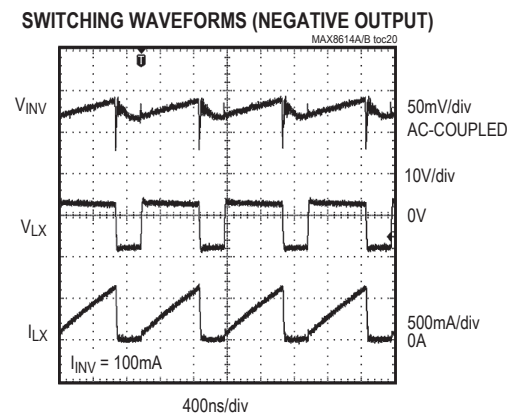
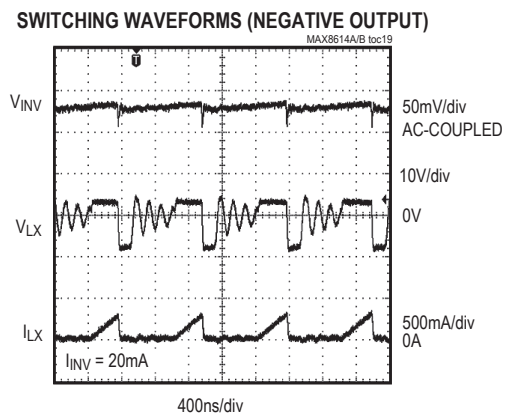
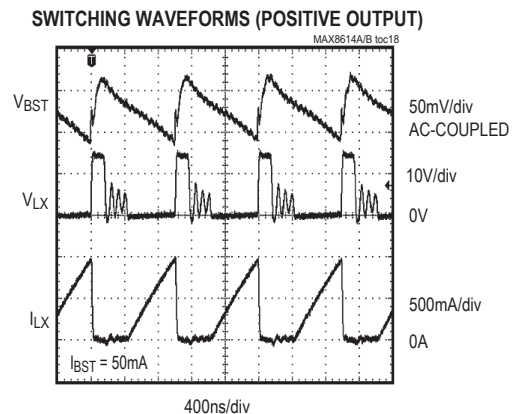
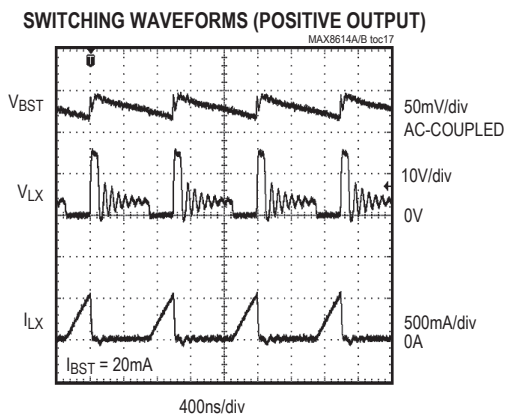
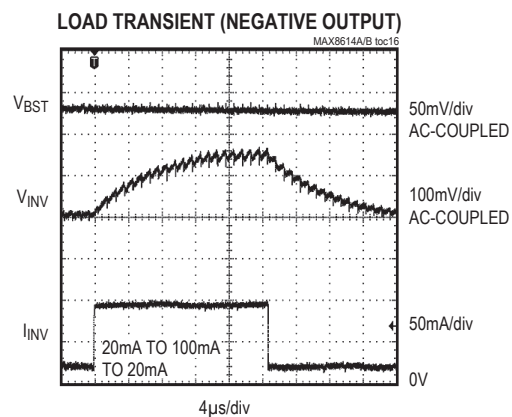
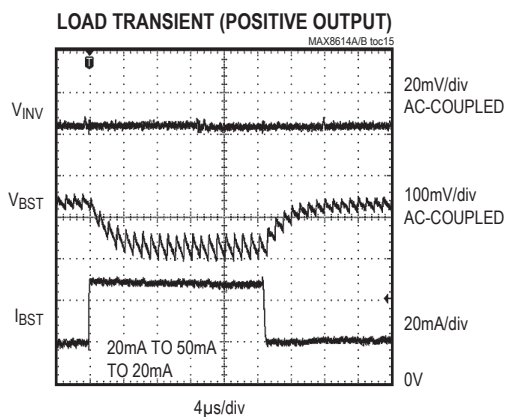
Typical Operating Characteristics

(T_A = +25°C, V_{CC} = V_{AVCC} = 3.6V, SEQ = GND, Figure 1, unless otherwise noted.)

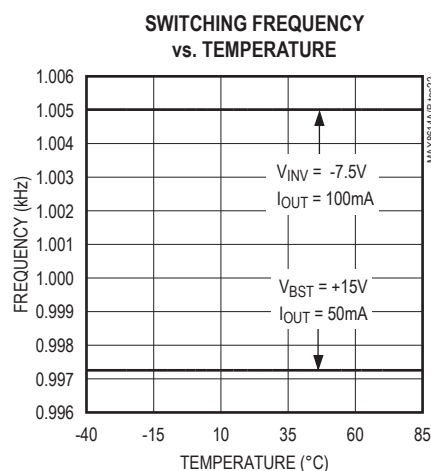
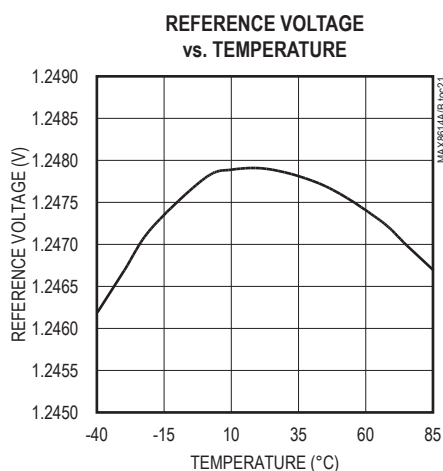
Typical Operating Characteristics (continued)

(T_A = +25°C, V_{CC} = V_{AVCC} = 3.6V, SEQ = GND, Figure 1, unless otherwise noted.)

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(T_A = +25°C, V_{CC} = V_{AVCC} = 3.6V, SEQ = GND, Figure 1, unless otherwise noted.)

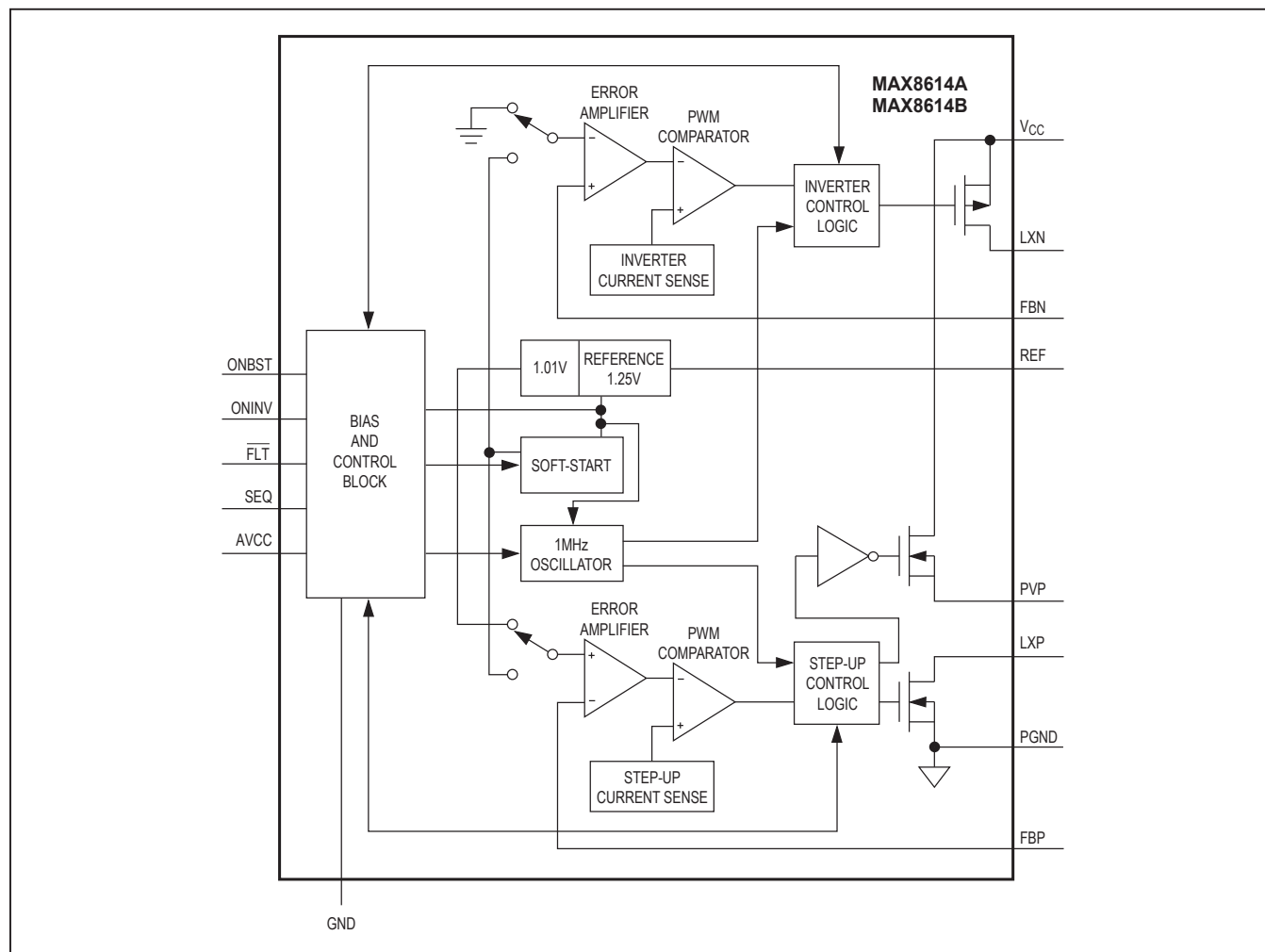
Typical Operating Characteristics (continued)

(T_A = +25°C, V_{CC} = V_{AVCC} = 3.6V, SEQ = GND, Figure 1, unless otherwise noted.)

Pin Description

PIN	NAME	FUNCTION
1	ONBST	Enable Logic Input. Connect ONBST to AVCC for automatic startup of the step-up converter, or use ONBST as an independent control of the step-up converter.
2	FBN	Negative Output Feedback Input. Connect a resistor-divider between the negative output and REF with the center to FBN to set the negative output voltage.
3	AVCC	Bias Supply. AVCC powers the IC. AVCC must be connected to V_{CC}.
4	REF	1.25V Reference Voltage Output. Bypass with a 0.22μF ceramic capacitor to GND.
5	GND	Ground. Connect GND to PGND with a short trace.
6	FLT	Fault Open-Drain Output. Connect a 100kΩ resistor from FLT to AVCC. FLT is active low during a fault event and is high impedance in shutdown.
7	FBP	Positive Output-Voltage Feedback Input. Connect a resistor-divider between the positive output and GND with the center to FBP to set the positive output voltage. FBP is high impedance in shutdown.
8	SEQ	Sequence Logic Input. When SEQ = low, power-on sequence can be independently controlled by ONBST and ONINV. When SEQ = high, the positive output powers up before the negative output.
9	ONINV	Enable Logic Input. Connect ONINV to AVCC for automatic startup of the inverter, or use ONINV as an independent control of the inverter.
10	LXP	Positive Output Switching Inductor Node. LXP is high impedance in shutdown.
11	PGND	Power Ground. Connect PGND to GND with a short trace.
12	PVP	True-Shutdown Load Disconnect Switch. Connect one side of the inductor to PVP and the other side to LXP. PVP is high impedance in shutdown.
13	V _{CC}	Power Input Supply. V _{CC} supplies power for the step-up and inverting DC-DC converters. V_{CC} must be connected to AVCC.
14	LXN	Negative Output Switching Inductor Node. LXN is high impedance in shutdown.
—	EP	Exposed Pad. Connect exposed pad to ground.

Functional Diagram



Detailed Description

The MAX8614A/MAX8614B generate both a positive and negative output voltage by combining a step-up and an inverting DC-DC converter on one IC. Both the step-up converter and the inverter share a common clock. Each output is independently regulated.

Each output is separately controlled by a pulse-width-modulated (PWM) current-mode regulator. This allows the converters to operate at a fixed frequency (1MHz) for use in noise-sensitive applications. The 1MHz switching rate allows for small external components. Both converters are internally compensated and are optimized for fast transient response (see the *Load Transient/Voltage Positioning* section).

Step-Up Converter

The step-up converter generates a positive output voltage up to 24V. An internal power switch, internal True-Shutdown load switch (PVP), and external catch diode allow conversion efficiencies as high as 90%. The internal load switch disconnects the battery from the load by opening the battery connection to the inductor, providing True Shutdown. The internal load switch stays on at all times during normal operation. The load switch is used in the control scheme for the converter and cannot be bypassed.

Inverter

The inverter generates output voltages down to -16V below V_{CC} . An internal power switch and external catch diode allow conversion efficiencies as high as 85%.

Control Scheme

Both converters use a fixed-frequency, PWM current-mode control scheme. The heart of the current-mode PWM controllers is a comparator that compares the error-amp voltage-feedback signal against the sum of the amplified current-sense signal and a slope-compensation ramp. At the beginning of each clock cycle, the internal power switch turns on until the PWM comparator trips. During this time the current in the inductor ramps up, storing energy in the inductor's magnetic field. When the power switch turns off, the inductor releases the stored energy while the current ramps down, providing current to the output.

Fault Protection

The MAX8614A/MAX8614B have robust fault and overload protection. After power-up, the device is set to detect an out-of-regulation state that could be caused by an overload or short condition at either output. If either output remains in overload for more than 100ms, both converters turn off and the \overline{FLT} flag asserts low. During a short-circuit condition longer than 100ms on the positive output, foldback current limit protects the output. During a short-circuit condition longer than 100ms on the negative output, both converters turn off and the \overline{FLT} flag asserts low. The converters then remain off until the device is reinitialized by resetting the controller.

The MAX8614A/MAX8614B also have thermal shutdown. When the device temperature reaches +170°C (typ), the device shuts down. When it cools down by 20°C (typ), the converters turn on.

Enable (ONBST/ONINV)

Applying a high logic-level signal to ONBST/ONINV turns on the converters using the soft-start and power-on sequencing described below. Pulling ONBST/ONINV low puts the IC in shutdown mode, turning off the internal circuitry. When ONBST/ONINV goes high (or if power is applied with ONBST/ONINV high), the power-on sequence is set by SEQ. In shutdown, the device consumes only 0.1µA and both output loads are disconnected from the input supply.

Soft-Start and Inrush Current

The step-up converter and inverter in the MAX8614A/MAX8614B feature soft-start to limit inrush current and minimize battery loading at startup. This is accomplished by ramping the reference voltage at the input of each error

amplifier. The step-up reference is ramped from 0 to 1V (where 1V is the desired feedback voltage for the step-up converter), while the inverter reference is ramped down from 1.25V to 0 (where 0 is the desired feedback voltage for the inverter).

During startup, the step-up converter True-Shutdown load switch turns on before the step-up-converter reference voltage is ramped up. This effectively limits inrush current peaks to below 500mA during startup.

Undervoltage Lockout (UVLO)

The MAX8614A/MAX8614B feature undervoltage-lockout (UVLO) circuitry, which prevents circuit operation and MOSFET switching when AVCC is less than the UVLO threshold (2.55V, typ). The UVLO comparator has 25mV of hysteresis to eliminate chatter due to the source supply output impedance.

Power-On Sequencing (SEQ)

The MAX8614A/MAX8614B have pin-selectable internally programmed power-on sequencing. This sequencing covers all typical sequencing options required by CCD imagers.

When SEQ = 0, power-on sequence can be independently controlled by ONINV and ONBST. When SEQ = 0 and ONINV and ONBST are pulled high, both outputs reach regulation simultaneously. The inverter is held off while the step-up True-Shutdown switch slowly turns on to pull PVP to V_{CC} . The positive output rises to a diode drop below V_{CC} . Once the step-up output reaches this voltage, the step-up and the inverter then ramp their respective references over a period of 7ms. This brings the two outputs into regulation at approximately the same time.

When SEQ = 1 and ONBST and ONINV are pulled high, the step-up output powers on first. The inverter is held off until the step-up completes its entire soft-start cycle and the positive output is in regulation. Then the inverter starts its soft-start cycle and achieves regulation in approximately 7ms.

True Shutdown

The MAX8614A/MAX8614B completely disconnect the loads from the input when in shutdown mode. In most step-up converters, the external rectifying diode and inductor form a DC current path from the battery to the output. This can drain the battery even in shutdown if a load is connected at the step-up converter output. The MAX8614A/MAX8614B have an internal switch between the input V_{CC} and the inductor node, PVP. When this switch turns off in shutdown there is no DC path from the input to the output of the step-up converter. This load disconnect is referred to as "True Shutdown." At the

inverter output, load disconnect is implemented by turning off the inverter's internal power switch.

Current-Limit Select

The MAX8614B allows an inductor current limit of 0.8A on the step-up converter and 0.75A on the inverter. The MAX8614A allows an inductor current limit of 0.44A on the step-up converter and 0.33A on the inverter. This allows flexibility in designing for higher load-current applications or for smaller, more compact designs when less power is needed. Note that the currents listed above are peak inductor currents and not output currents. The MAX8614B output current is 50mA at +15V and 100mA at -7.5V. The MAX8614A output current is 25mA at +15V and 50mA at -7.5V.

Load Transient/Voltage Positioning

The MAX8614A/MAX8614B match the load regulation to the voltage droop seen during load transients. This is sometimes called voltage positioning. This results in minimal overshoot when a load is removed and minimal voltage drop during a transition from light load to full load.

The use of voltage positioning allows superior load-transient response by minimizing the amplitude of overshoot and undershoot in response to load transients. DC-DC converters with high control-loop gains maintain tight DC load regulation, but still allow large voltage drops of 5% or greater for several hundred microseconds during transients. Load-transient variations are seen only with an oscilloscope (see the *Typical Operating Characteristics*). Since DC load regulation is read with a voltmeter, it does not show how the power supply reacts to load transients.

Applications Information

Adjustable Output Voltage

The positive output voltage is set by connecting FBP to a resistive voltage-divider between the output and GND (Figure 1). Select feedback resistor R2 in the 30kΩ to 100kΩ range. R1 is then given by:

$$R1 = R2 \left(\frac{V_{BST}}{V_{FBP}} - 1 \right)$$

where $V_{FBP} = 1.01V$.

The negative output voltage is set by connecting FBN to a resistive voltage-divider between the output and REF (Figure 1). Select feedback resistor R4 in the 30kΩ to 100kΩ range. R3 is then given by:

$$R3 = R4 \times \left(\frac{V_{FBN} - V_{IMV}}{V_{REF} - V_{FBN}} \right)$$

where $V_{REF} = 1.25V$ and $V_{FBN} = 0V$.

Inductor Selection

The MAX8614A/MAX8614B high switching frequency allows for the use of a small inductor. The 4.7μH and 2.2μH inductors shown in the *Typical Operating Circuit* is recommended for most applications. Larger inductances reduce the peak inductor current, but may result in skipping pulses at light loads. Smaller inductances require less board space, but may cause greater peak current due to current-sense comparator propagation delay.

Use inductors with a ferrite core or equivalent. Powder iron cores are not recommended for use with high switching frequencies. The inductor's incremental saturation rating must exceed the selected current limit. For highest efficiency, use inductors with a low DC resistance (under 200mΩ); however, for smallest circuit size, higher resistance is acceptable. See Table 1 for a representative list of inductors and Table 2 for component suppliers.

Diode Selection

The MAX8614A/MAX8614B high switching frequency demands a high-speed rectifier. Schottky diodes, such as the CMHSH5-2L or MBR0530L, are recommended. Make sure that the diode's peak-current rating exceeds the selected current limit, and that its breakdown voltage exceeds the output voltage. Schottky diodes are preferred due to their low forward voltage. However, ultra-high-speed silicon rectifiers are also acceptable. Table 2 lists component suppliers.

Capacitor Selection

Output Filter Capacitor

The primary criterion for selecting the output filter capacitor is low effective series resistance (ESR). The product of the peak inductor current and the output filter capacitor's ESR determines the amplitude of the high-frequency ripple seen on the output voltage. These requirements can be balanced by appropriate selection of the current limit.

For stability, the positive output filter capacitor (C1) should satisfy the following:

$$C1 > (6L I_{BSTMAX}) / (R_{CS} D + V_{BST}^2)$$

where $R_{CS} = 0.015$ (MAX8614B), and 0.035 (MAX8614A), and D+ is 1 minus the step-up switch duty cycle and is:

$$D+ = V_{CC}/V_{BST}$$

Table 1. Inductor Selection Guide

OUTPUT VOLTAGES AND LOAD CURRENT	INDUCTOR	L (μH)	DCR (mΩ)	I _{SAT} (A)	SIZE (mm)
15V, 50mA -7.5V, 100mA	TOKO DB3018C, 1069AS-2R0	2.0	72	1.4	3 x 3 x 1.8
	TOKO DB3018C, 1069AS-4R3	4.3	126	0.97	3 x 3 x 1.8
	TOKO S1024AS-4R3M	4.3	47	1.2	4 x 4 x 1.7
	Sumida CDRH2D14-4R7	4.7	170	1	3.2 x 3.2 x 1.55
	TOKO S1024AS-100M	10	100	0.8	4 x 4 x 1.7
15V, 20mA -7.5V, 40mA	Sumida CDRH2D11-100	10	400	0.35	3.2 x 3.2 x 1.2
	Sumida CDRH2D14-100	10	295	0.46	3.2 x 3.2 x 1.55
	Murata LQH32CN100K33	10	300	0.45	3.2 x 2.5 x 2

Table 2. Component Suppliers

SUPPLIER	PHONE	WEBSITE
INDUCTORS		
Murata	770-436-1300	www.murata.com
Sumida	847-545-600	www.sumida.com
TOKO	847-297-0070	www.tokoam.com
DIODES		
Central Semiconductor (CMHSH5-2L)	631-435-1110	www.centrasemi.com
Motorola (MBR0540L)	602-303-5454	www.motorola.com
CAPACITORS		
Taiyo Yuden	408-573-4150	www.t-yuden.com
TDK	888-835-6646	www.TDK.com

For stability, the inverter output filter capacitor (C2) should satisfy the following:

$$C2 > (6L V_{REF} I_{INVMAX}) / (R_{CS} D - (V_{REF} - V_{INV}) V_{INV})$$

where $R_{CS} = 0.0175$ (MAX8614B), and 0.040 (MAX8614A), and D - is 1 minus the inverter switch duty cycle and is:

$$D- = V_{CC}/V_{INV}$$

Table 2 lists representative low-ESR capacitor suppliers.

Input Bypass Capacitor

Although the output current of many MAX8614A/MAX8614B applications may be relatively small, the input must be designed to withstand current transients equal to the inductor current limit. The input bypass capacitor reduces the peak currents drawn from the voltage source, and reduces noise caused by the MAX8614A/MAX8614B switching action. The input source impedance determines the size of the capacitor required at the input. As with the output filter capacitor, a low-ESR capacitor is recommended. A 22μF, low-ESR capacitor is adequate for most applications, although smaller bypass capacitors may also be acceptable with low-impedance sources, or if the source supply is already well filtered. Bypass AVCC separately from V_{CC} with a 1.0μF ceramic capacitor placed as close as possible to the AVCC and GND pins.

PCB Layout and Routing

Proper PCB layout is essential due to high-current levels and fast-switching waveforms that radiate noise. Breadboards or protoboards should never be used when prototyping switching regulators.

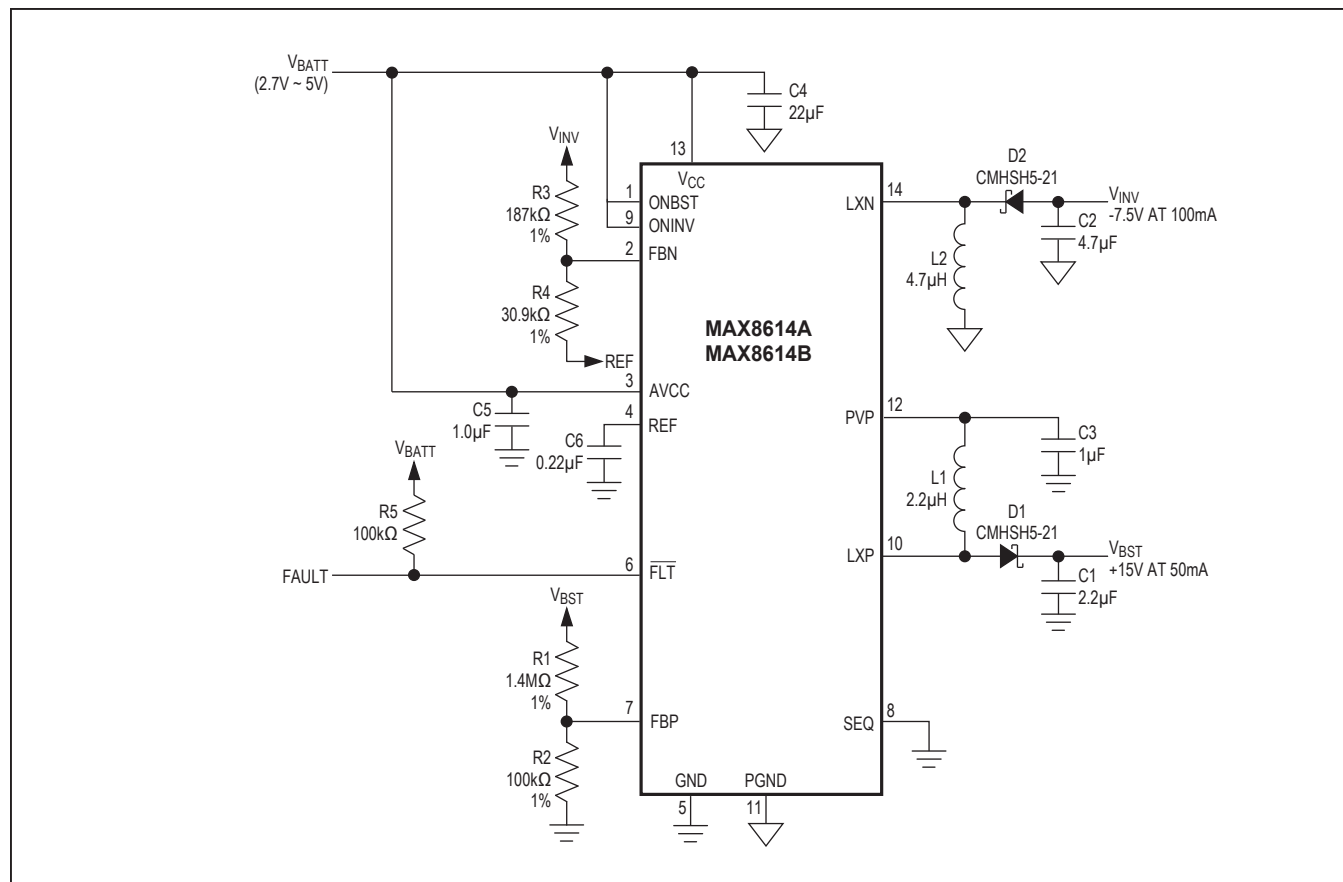


Figure 1. Typical Application Circuit

It is important to connect the GND pin, the input bypass-capacitor ground lead, and the output filter-capacitor ground lead to a single point (star ground configuration) to minimize ground noise and improve regulation. Also, minimize lead lengths to reduce stray capacitance, trace resistance, and radiated noise, with

preference given to the feedback circuit, the ground circuit, and LX_. Place feedback resistors R1–R4 as close as possible to their respective feedback pins. Place the input bypass capacitor as close as possible to AVCC and GND.

Chip Information

PROCESS: BiCMOS

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
14 TDFN	T1433+2	21-0137	90-0063

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
2	6/14	Added MAX8614ETD/V+ to <i>Ordering Information</i>	1
3	12/19	Added EC table for MAX8614BATD/V+	3

For pricing, delivery, and ordering information, please visit Maxim Integrated's online storefront at <https://www.maximintegrated.com/en/storefront/storefront.html>.

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